

# SHARP

OPTO-ANALOG DEVICES DIVISION ELECTRONIC COMPONENTS GROUP SHARP CORPORATION

# **SPECIFICATION**

DEVICE SPECIFICATION FOR	
PHOTOCO MODEL No.	DUPLER
PC40	00
(Business dealing name	: PC400J00000F)
Specified for	
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Product name:	PHOTOCOUPLER
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Model No.: PC400

(Business dealing name: PC400J00000F)

- 1. These specification sheets include materials protected under copyright of Sharp Corporation ("Sharp"). Please do not reproduce or cause anyone to reproduce them without Sharp's consent.
- 2. When using this product, please observe the absolute maximum ratings and the instructions for use outlined in these specification sheets, as well as the precautions mentioned below. Sharp assumes no responsibility for any damage resulting from use of the product which does not comply with the absolute maximum ratings and the instructions included in these specification sheets, and the precautions mentioned below.

(Precautions)

- (1) This product is designed for use in the following application areas;
  - · OA equipment Audio visual equipment · Home appliances
  - · Telecommunication equipment (Terminal) · Measuring equipment
  - · Tooling machines · Computers

If the use of the product in the above application areas is for equipment listed in paragraphs (2) or (3), please be sure to observe the precautions given in those respective paragraphs.

- (2) Appropriate measures, such as fail-safe design and redundant design considering the safety design of the overall system and equipment, should be taken to ensure reliability and safety when this product is used for equipment which demands high reliability and safety in function and precision, such as;
  - · Transportation control and safety equipment (aircraft, train, automobile etc.)
  - · Traffic signals · Gas leakage sensor breakers · Rescue and security equipment
  - · Other safety equipment
- (3) Please do not use this product for equipment which require extremely high reliability and safety in function and precision, such as;
  - · Space equipment · Telecommunication equipment (for trunk lines)
  - · Nuclear power control equipment · Medical equipment
- (4) Please contact and consult with a Sharp sales representative if there are any questions regarding interpretation of the above three paragraphs.
- 3. Please contact and consult with a Sharp sales representative for any questions about this product.



1. Application

This specification applies to the outline and characteristics of OPIC photocoupler Model No. PC400(Lead free type).

2. Outline

Refer to the attached sheet, page 4

3. Ratings and characteristics

Refer to the attached sheet, page 5 to 7.

4. Reliability

Refer to the attached sheet, page 8.

5. Outgoing inspection

Refer to the attached sheet, page 9.

## 6. Supplement

- 6.1 Isolation voltage shall be measured in the following method.
- (1) Short between pins 1 and 3 on the primary side and between pins 4, 5 and 6 on the secondary side.
- (2) The dielectric withstanding tester with zero-cross circuit shall be used.
- (3) The wave form of applied voltage shall be a sine wave.
  (It is recommended that the isolation voltage be measured in insulation oil.)
- 6.2 Package specification

Refer to the attached sheet, page 10, 11.

- 6.3 The business dealing name used for this product when ordered or delivered shall be PC400J00000F.
- 6.4 This Model is approved by UL.

Approved Model No.: PC400

UL file No.: E64380

6.5 This product is not designed against irradiation.

This product is operated with electrical input and output.

This product incorporates non-coherent light emitting diode.

6.6 ODS materials

This product shall not contain the following materials.

Also, the following materials shall not be used in the production process for this product.

Materials for ODS : CFC<sub>S</sub>, Halon, Carbon tetrachloride, 1.1.1-Trichloroethane (Methyl chloroform)

6.7 Specified brominated flame retardants

Specified brominated flame retardants (PBB and PBDE) are not used in this device at all.

- 6.8 Explanation of operation
  - (1) When the forward current over the "H→L" threshold input current (I<sub>FHL</sub>) is flows on the input side, the output goes to "Low level".
  - (2) When the forward current goes below the "L→H" threshold input current (I<sub>FLH</sub>) is flows on the input side, the output goes to "High level".



## 6.9 Compliance with each regulation

(1) The RoHS directive (2002/95/EC)

This product complies with the RoHS directive (2002/95/EC).

Object substances: mercury, lead, cadmium, hexavalent chromium, polybrominated biphenyls (PBB) and polybrominated diphenyl ethers (PBDE)

(2) Content of six substances specified in Management Methods for Control of Pollution Caused by Electronic Information Products Regulation (Chinese: 电子信息产品污染控制管理办法).

		<del></del>	Toxic and	l hazardous subs	stances	
Category	Lead (Pb)	Mercury (Hg)	Cadmium (Cd)	Hexavalent chromium (Cr <sup>6+</sup> )	Polybrominated biphenyls (PBB)	Polybrominated diphenyl ethers (PBDE)
Photocoupler	<b>√</b>	1	<b>√</b>	1	1	<b>√</b>

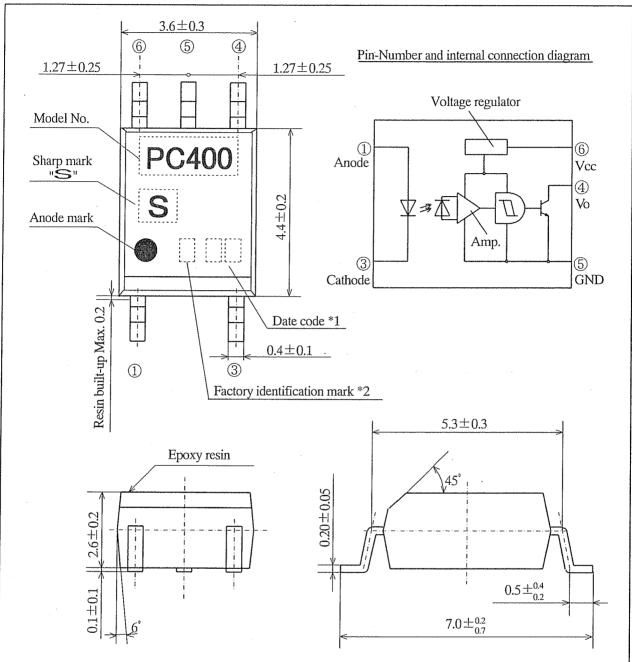
 $<sup>\</sup>checkmark$ : indicates that the content of the toxic and hazardous substance in all the homogeneous materials of the part is below the concentration limit requirement as described in SJ/T 11363-2006 standard.

#### 7. Notes

Precautions for photocouplers : Attachment-1



### 2. Outline



- \*1) 2-digit number shall be marked according to OLD DIN standard.
- \*2) Factory identification mark applies to the below.

Without: SUN-S Corporation (Japan)

Pin material: 42 Alloy

Pin finish: SnCu plating (Cu: TYP. 2%)

Marking is ink marking

P.T.SHARP SEMICONDUCTOR INDONESIA (INDONESIA)

Pin material: Cu Alloy

Pin finish: Palladium (Au flash plating)

Marking is laser marking

Product mass: Approx. 0.1g

UNIT: 1/1 mm
PC400 Outline Dimensions

(Business dealing name: PC400J00000F)

Name



# 3. Ratings and characteristics

# 3.1 Absolute maximum ratings

Ta=25℃

<del>}</del>		——————————————————————————————————————		14-20-0	
		Parameter	Symbol	Rating	Unit
	*1	Forward current	$I_{F}$	50	mA
Input		Reverse voltage	V <sub>R</sub>	6	V
		Power dissipation	P	70	mW
		Supply voltage	Vcc	16	V
Output		High level output voltage	V <sub>OH</sub>	16	V
Output		Low level output current	I <sub>OL</sub>	50	mA
	*1	Collector power dissipation	Po	130	mW
	*1	Total power dissipation	P <sub>tot</sub>	150	mW
	*2	Isolation voltage	V <sub>iso(rms)</sub>	3750	V
		Operating temperature	Topr	-25 to +85	°C
		Storage temperature	$T_{ m stg}$	-40 to +125	$^{\circ}$ C
	*3	Soldering temperature	$T_{sol}$	260	℃ .

 $<sup>^*1</sup>$  The dealing factors of absolute maximum ratings due to ambient temperature are shown in Fig. 1 to 3.

<sup>\*2</sup> AC for 1 min, 40 to 60%RH

<sup>\*3</sup> For 10 s



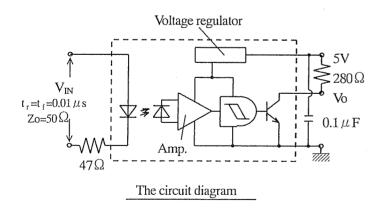
3.2 Electro-optical characteristics

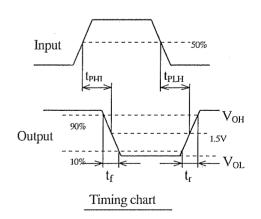
(Ta=0 to 70°C unless otherwise specified)

	Parameter		Symbol	MIN.	TYP.	MAX.	Unit	Conditions
	For	ward voltage	V <sub>F</sub>	_	1.1	1.4	V	I <sub>F</sub> =4mA
Input	101	ward voltage	V F	0.7	1.0			I <sub>F</sub> =0.3mA
la la	Rev	verse current	$I_R$	_		10	μА	$Ta=25^{\circ}C, V_R=3V$
	Ter	minal capacitance	Ct	-	30	250	pF	Ta=25°C, $V_F$ =0 f=1MHz
	Op	erating supply voltage range	Vcc	3		15	V	
#	Lov	w level output voltage	V <sub>OL</sub>	-	0.2	0.4	V	I <sub>OL</sub> =16mA, Vcc=5V, I <sub>F</sub> =4mA
Output	Hig	th level output current	I <sub>OH</sub>		-	100	$\mu$ A	Vcc=Vo=15V, I <sub>F</sub> =0
	Lov	w level supply current	$I_{CCL}$	-	2.5	5.0	mA	Vcc=5V, I <sub>F</sub> =4mA
	Hig	th level supply current	$I_{CCH}$	-	1.0	5.0	mA	Vcc=5V, I <sub>F</sub> =0
	"H-	→L" threshold input current	I <sub>FHIL</sub>	-	1.1	2.0	mA	Ta=25°C, $V_{cc}$ =5V, $R_L$ =280 $\Omega$
	*	1		-	-	4.0		Vcc=5V, $R_L$ =280 $\Omega$
		'L→H" threshold input current		0.4	0.8	-	mA	Ta=25°C, $V_{cc}$ =5V, $R_L$ =280 $\Omega$
stic	*	2	I <sub>FLH</sub>	0.3	•	_		Vcc=5V, $R_L$ =280 $\Omega$
teri	Hys	steresis *3	I <sub>FLH</sub> / I <sub>FHL</sub>	0.5	0.7	0.9		Vcc=5V, $R_L$ =280 $\Omega$
arac	Isol	ation resistance	R <sub>ISO</sub>	5×10 <sup>10</sup>	1011	-	Ω	Ta=25°C, DC500V, 40 to 60%RH
Transfer characteristics	ne *4	"H→L" propagation delay time	t <sub>PHIL</sub>	-	1	3		
Tra	Response time	"L→H" propagation delay time	t <sub>PLH</sub>	-	2	6	μs	Ta=25°C, Vcc=5V, $I_F$ =4mA, $R_L$ =280 $\Omega$
	(esp	Fall time	$t_f$		0.05	0.5		
	)-L-(	Rise time	t <sub>r</sub>	_	0.1	0.5		

<sup>\*1</sup> I<sub>FHL</sub> represents forward current when output changes from "H" to "L".

<sup>\*4</sup> Test circuit for response time shall be shown below.

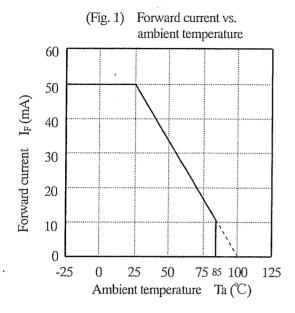


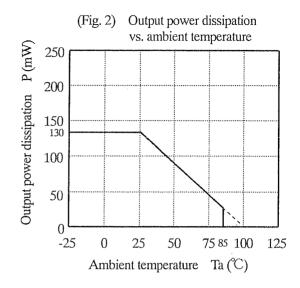


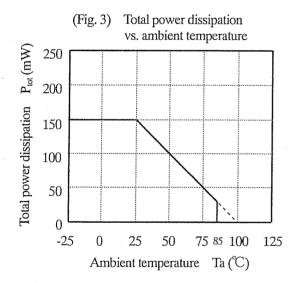
<sup>\*2</sup> I<sub>FLH</sub> represents forward current when output changes from "L" to "H".

<sup>\*3</sup> Hysteresis:  $I_{FLH}/I_{FHL}$ 











## 4. Reliability

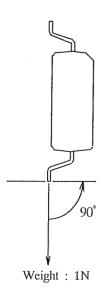
The reliability of products shall satisfy items listed below.

Confidence level: 90%

LTPD: 10 or 20

	LII D . 10 01 20		
Test Items	Test Conditions *1	Failure Judgment Criteria	Samples (n) Defective(C)
Solderability *2	245±3℃,5s		n=11, C=0
Soldering heat *3	(Flow soldering) 260°C, 10 s	***	n=11, C=0
Gordering heat 5	(Soldering by hand) 400°C, 3 s		n=11, C=0
Terminal strength (Bending) *4	Weight: 1N 1 time/each terminal		n=11, C=0
Mechanical shock	$15 \text{km/s}^2$ , 0.5ms $3 \text{ times/} \pm \text{X}$ , $\pm \text{Y}$ , $\pm \text{Z}$ direction	$egin{array}{cccc} V_F &>& U\times 1.2 \\ I_R &>& U\times 2 \\ \end{array}$	n=11, C=0
Variable frequency vibration	100 to 2000 to 100Hz/4min 200m/s <sup>2</sup> 4 times/ X, Y, Z direction	$V_{OL}$ $>U\times1.2$ $I_{OH}$ $>U\times1.2$ $I_{CCI}$ $>U\times1.2$	n=11, C=0
Temperature cycling	1 cycle -40°C to +125°C (30min) (30min) 20 cycles test	$ \begin{array}{c c} I_{CCH} & > U \times 1.2 \\ I_{FHL} & > U \times 1.3 \\ I_{FLH} & < L \times 0.8 \end{array} $	n=22,C=0
High temp. and high humidity storage *5	+85℃, 85%RH, 500h	$I_{FLH}/I_{FHL} \neq L \times 0.8$ $\sim U \times 1.2$	n=22,C=0
High temp. storage	+125℃, 1000h	U: Upper specification limit	n=22,C=0
Low temp. storage	-40℃, 1000h	L: Lower specification limit	n=22,C=0
Operation life	I <sub>F</sub> =10mA, Vcc=15V, I <sub>OL</sub> =16mA Ta=25°C 1000h		n=22,C=0

- \*1 Test method, conforms to EIAJ ED 4701.
- \*2 Solder shall adhere at the area of 95% or more of immersed portion of lead, and pin hole or other holes shall not be concentrated on one portion.
- \*3 It is evaluated due to the temperature profile in attachment-1.
- \*4 Terminal bending direction is shown below.
- \*5 It is evaluated after washing by specified solvent in attachment-1.





# 5. Outgoing inspection

# 5.1 Inspection items

 $(1) \quad \mbox{Electrical characteristics} \\ \quad \mbox{$V_F$, $I_R$, $V_{OL}$, $I_{OH}$, $I_{CCL}$, $I_{CCH}$, $I_{FHL}$, $I_{FLH}$, $R_{ISO}$, $V_{iso}$} \\$ 

(2) Appearance

# 5.2 Sampling method and Inspection level

A single sampling plan, normal inspection level II based on ISO 2859 is applied. The AQL according to the inspection items are shown below.

Defect	Inspection item	AQL(%)
Major defect	Electrical characteristics Unreadable marking	0.065
Minor defect	Appearance defect except the above mentioned.	0.25



#### 6.2 Package specifications

#### 6.2.1 Taping conditions

- (1) Tape structure and Dimensions (Refer to the attached sheet, Page 10)

  The carrier tape has the heat pressed structure of A-PET material carries tape with preventing static electricity and three layers cover tape (PET material base).
- (2) Reel structure and Dimensions (Refer to the attached sheet, Page 11) The taping reel shall be of plastic (PS material).
- (3) Direction of product insertion (Refer to the attached sheet, Page 11)
- (4) Joint of tape

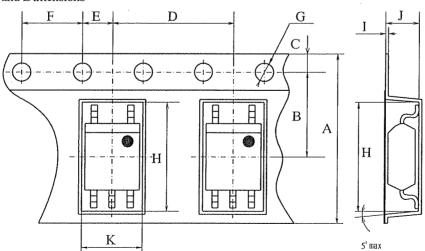
The cover tape and carrier tape in one reel shall be joint less.

- (5) To repair failure taped devices, cutting a bottom of carrier tape with a cutter. After replacing the cut portion shall be sealed with adhesive tape.
- 6.2.2 Adhesiveness of cover tape
  - The exfoliation force between carrier tape and cover tape shall be 0.2N to 0.7N for the angle  $160^{\circ}$  to  $180^{\circ}$ .
- 6.2.3 Rolling method and quantity
  - Wind the tape back on the reel so that the cover tape will be outside the tape.
     Attach more than 20cm of blank tape to the trailer and the leader of the tape and fix the both ends with adhesive tape.
     One reel basically shall contain 3000pcs.
- 6.2.4 Outer packing appearance (Refer to attached sheet, Page 11.)
- 6.2.5 Marking
  - The label with following information shall be pasted at appointed place of the outer packing case.
    - \* Model No. \*(Business dealing name) \* Lot No. \* Quantity
    - \* Country of origin \*Company name \*Inspection date specified

#### 6.2.6 Storage condition

- Taped products shall be stored at the temperature 5 to 30°C and the humidity 70%RH or less away from direct sunlight.
- 6.2.7 Safety protection during shipping
  - · There shall be no deformation of component or degradation of electrical characteristics due to shipping.

#### Carrier tape structure and Dimensions



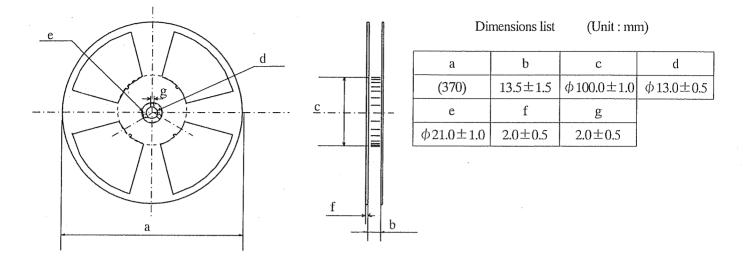
Dimensions list (Unit: mm)

Α	В	С	D	Е	F	G	Н	I	J	K
						+0.1				
±0.3	±0.05	$\pm 0.10$	$\pm 0.1$	±0.1	$\pm 0.1$	-0.0	士0.1	$\pm 0.05$	±0.1	±0.1
12.0	5.50	1.75	8.0	2,0	4.0	Ф1.5	7.4	0.30	3.1	4.0

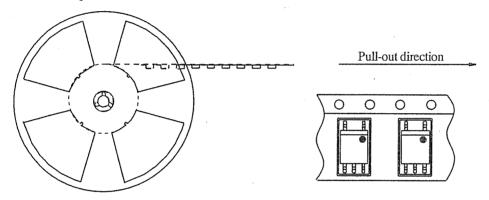
10/11



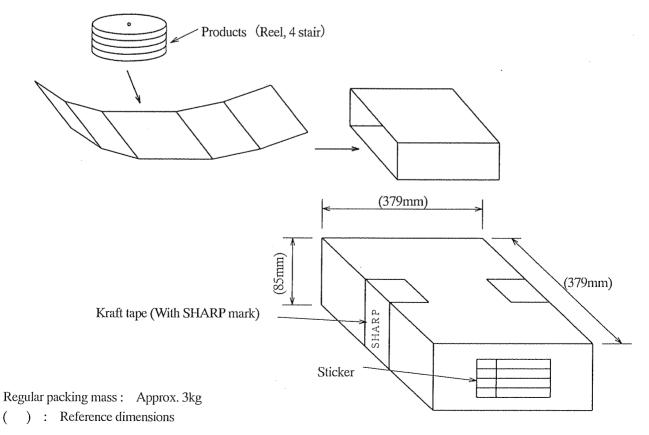
## Reel structure and Dimensions



# Direction of product insertion



# Outer packing appearance





#### Precautions for Photocouplers

#### 1 Cleaning

(1) Solvent cleaning: Solvent temperature 45°C or less

Immersion for 3 min or less

(2) Ultrasonic cleaning: The effect to device by ultrasonic cleaning differs by cleaning bath size, ultrasonic power output,

cleaning time, PCB size or device mounting condition etc. Please test it in actual using condition

and confirm that any defect doesn't occur before starting the ultrasonic cleaning.

(3) Applicable solvent: Ethyl alcohol, Methyl alcohol, Isopropyl alcohol

When the other solvent is used, there are cases that the packaging resin is eroded.

Please use the other solvent after thorough confirmation is performed in actual using condition.

#### 2. Static electricity

Transistor of detector side in bipolar configuration is apt to be affected by static electricity for its minute design.

When handling them, general counterpane against static electricity should be taken to avoid breakdown of devices or degradation of characteristics.

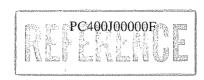
#### 3. Circuit design

- (1) In order to stabilize power supply line, we recommend to connect a by-pass capacitor of  $0.01 \,\mu$  F or more between Vcc and GND near the device.
- (2) The LED used in the Photocoupler generally decreases the light emission power by operation. In case of long operation time, please design I<sub>F</sub> value so that I<sub>F</sub> is twice or more of the Maximum value of the "H→L" threshold input current at circuit design with considering the decreases of the light emission power of the LED. (50%/5years)
- (3) The detector which is used in this device has parasitic diode between each pins and GND.

There are cases that miss operation or destruction may be occurred if electric potential of any pin fall below GND level in an instant.

Therefore it is recommended to design the circuit that electric potential of any pin does not become below GND level.

(4) When steep voltage noise is applied between the primary side and the secondary side of the photocoupler, current flows or changes in the light emitting diode through a parasitic capacitance between the primary side and the secondary side of the photocoupler, then there is a case that miss operation occurs depending upon the applied noise level. We should certainly recommend to use a by-pass capacitor between both terminals of the light emitting diode when used in noisy environment.

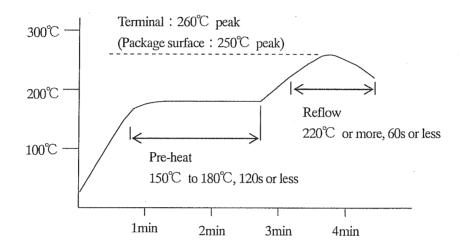


#### 4. Precautions for Soldering

(1) In the case of flow soldering (Whole dipping is possible.) It is recommended that flow soldering should be at  $260^{\circ}$ C or less for 10 s or less (Pre-heating:  $100 \text{ to } 150^{\circ}$ C, 30 to 80 s). (2 times or less)

#### (2) If solder reflow:

It is recommended to be done at the temperature and the time within the temperature profile as shown in the figure below. (2 times or less)



#### (3) In the case of hand soldering

What is done on the following condition is recommended. (2 times or less)

Soldering iron temperature:  $400^{\circ}$ C or less

Time: 3s or less

#### (4) Other precautions

Depending on equipment and soldering conditions (temperature, Using solder etc.), the effect to the device and the PCB is different.

Please confirm that there is no problem on the actual use conditions in advance